

ASM3P2775A

Product Preview

Low Power Peak EMI Reducing Solution

Description

The ASM3P2775A is a versatile spread spectrum frequency modulator designed specifically for a wide range of clock frequencies. The ASM3P2775A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of all clock dependent signals. The ASM3P2775A allows significant system cost savings by reducing the number of circuit board layers, ferrite beads and shielding that are traditionally required to pass EMI regulations.

The ASM3P2775A uses the most efficient and optimized modulation profile approved by the FCC and is implemented by using a proprietary all digital method.

The ASM3P2775A modulates the output of a single PLL in order to “spread” the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal’s bandwidth is called ‘spread spectrum clock generation.’

Applications

The ASM3P2775A is targeted towards all portable devices with very low power requirements like MP3 players and digital still cameras.

Features

- Generates an EMI Optimized Clock Signal at the Output
- Integrated Loop Filter Components
- Operates with a 3.3 V Supply
- Operating Current less than 4 mA
- Low Power CMOS Design
- Input Frequency Range: 13 MHz to 30 MHz
- Generates a 1X Low EMI Spread Spectrum Clock of the Input Frequency
- Frequency Deviation: $\pm 1.8\%$ (Typ) @ 14.7 MHz Input Frequency
- Available in 6-pin TSOT-23, 8-pin SOIC and 8-pin TSSOP Packages
- Commercial Temperature Range
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

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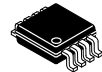
<http://onsemi.com>



TSOT-6
O SUFFIX
CASE 419AF

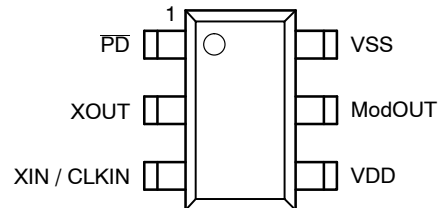


TSSOP-8
T SUFFIX
CASE 948AL

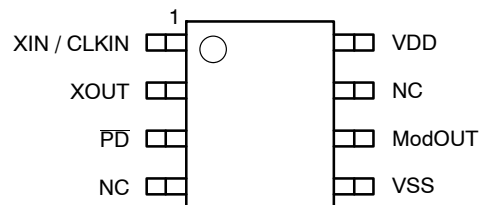


SOIC-8
S SUFFIX
CASE 751BD

PIN CONFIGURATIONS



6-Pin TSOT-23 Package
(Top View)



8-Pin SOIC and TSSOP Packages
(Top View)

KEY SPECIFICATIONS

Description	Specification
Supply Voltage	VDD = 3.3 V \pm 0.3 V
Cycle-to-Cycle Jitter	200 pS (Typ)
Output Duty Cycle	45/55% (worst case)
Modulation Rate Equation	$F_{IN}/640$
Frequency Deviation	$\pm 1.8\%$ (Typ) @ 14.7 MHz

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

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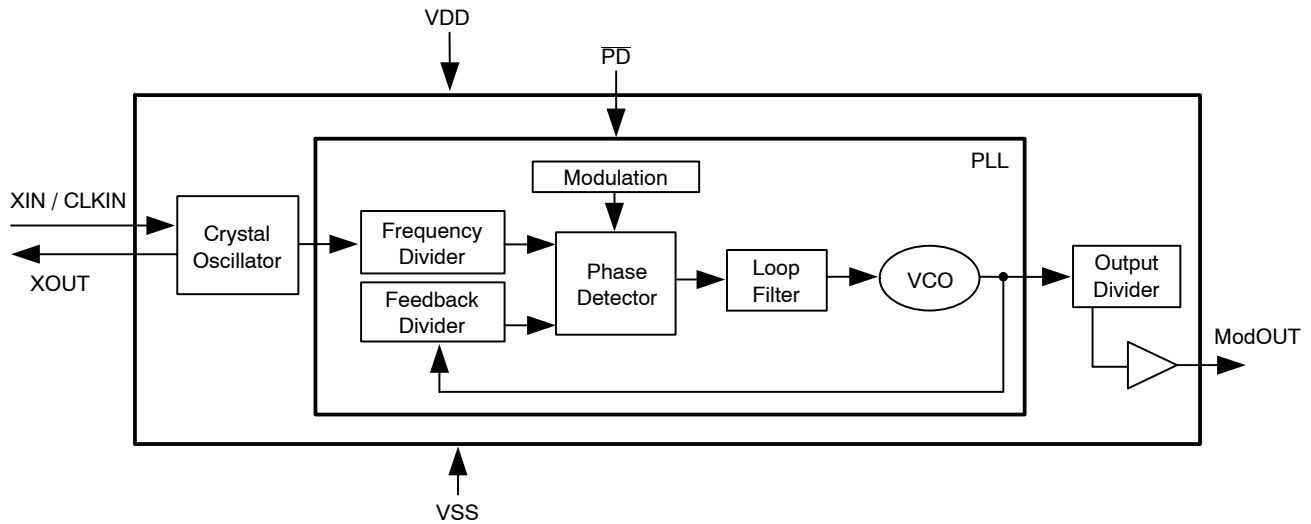


Figure 1. Block Diagram

Table 1. PIN DESCRIPTION (6-Pin TSOT-23 Package)

Pin#	Pin Name	Type	Description
1	\overline{PD}	I	Power-down control pin. Pull low to enable power-down mode. Connect to VDD if not used.
2	XOUT	O	Crystal connection. If using an external reference, this pin must be left unconnected.
3	XIN / CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.
4	VDD	P	Power supply for the entire chip.
5	ModOUT	O	Spread spectrum clock output.
6	VSS	P	Ground connection.

Table 2. PIN DESCRIPTION (8-Pin SOIC and TSSOP Packages)

Pin#	Pin Name	Type	Description
1	XIN / CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.
2	XOUT	O	Crystal connection. If using an external reference, this pin must be left unconnected.
3	\overline{PD}	I	Power-down control pin. Pull low to enable power-down mode. Connect to VDD if not used.
4	NC	-	No connect.
5	VSS	P	Ground connection.
6	ModOUT	O	Spread spectrum clock output.
7	NC	-	No connect.
8	VDD	P	Power supply for the entire chip.

ASM3P2775A

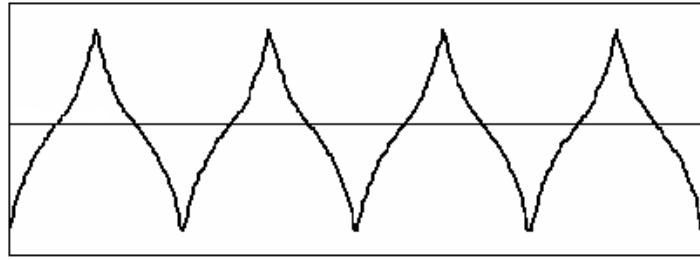


Figure 2. Modulation Profile

Table 3. SPECIFICATIONS

Description	Specification
Frequency Range	13 MHz < CLKIN < 30 MHz
Modulation Equation	$F_{IN}/640$
Frequency Deviation	$\pm 1.8\%$ (Typ) @ 14.7 MHz

Table 4. ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Rating	Unit
VDD, VIN	Voltage on any pin with respect to Ground	-0.5 to +4.6	V
TSTG	Storage temperature	-65 to +125	°C
TA	Operating temperature	-40 to +85	°C
TS	Max. Soldering Temperature (10 sec)	260	°C
TJ	Junction Temperature	150	°C
TDV	Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 5. DC ELECTRICAL CHARACTERISTICS

(Test condition: All parameters are measured at room temperature (+25°C) unless otherwise stated.)

Symbol	Parameter	Min	Typ	Max	Unit
VIL	Input low voltage	VSS-0.3	-	0.8	V
VIH	Input high voltage	2.0	-	VDD+0.3	V
IIL	Input low current	-	-	-35	μA
IIH	Input high current	-	-	35	μA
IXOL	XOUT output low current (@ 0.4 V, VDD = 3.3 V)	-	3	-	mA
IXOH	XOUT output high current (@ 2.5 V, VDD = 3.3 V)	-	3	-	mA
VOL	Output low voltage (VDD = 3.3 V, IOL = 8 mA)	-	-	0.4	V
VOH	Output high voltage (VDD = 3.3 V, IOH = 8 mA)	2.5	-	-	V
IDD	Static supply current (Note 1)	-	-	10	μA
ICC	Dynamic supply current (3.3 V, 16 MHz and no load)	-	3.5	-	mA
VDD	Operating voltage	3.0	3.3	3.6	V
tON	Power-up time (first locked cycle after power-up) (Note 2)	-	-	5	mS
ZOUT	Output impedance	-	45	-	Ω

1. XIN / CLKIN pin and \overline{PD} pin are pulled low.
2. VDD and XIN / CLKIN input are stable, \overline{PD} pin is made high from low.

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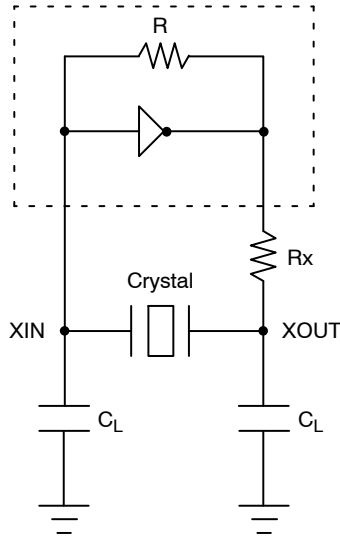
Table 6. AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Typ	Max	Unit	
CLKIN	Input frequency	13	-	30	MHz	
ModOUT	Output frequency	13	-	30	MHz	
f_d	Frequency Deviation	Input Frequency = 13 MHz	-	±1.85	-	%
		Input Frequency = 30 MHz	-	±1.45	-	
t_{LH} (Note 3)	Output rise time (measured at 0.8 V to 2.0 V)	0.5	1.1	1.3	nS	
t_{HL} (Note 3)	Output fall time (measured at 2.0 V to 0.8 V)	0.3	0.8	1.0	nS	
t_{JC}	Jitter (cycle-to-cycle)	-	200	300	pS	
t_D	Output duty cycle	45	50	55	%	

3. t_{LH} and t_{HL} are measured into a capacitive load of 15 pF.

Table 7. TYPICAL CRYSTAL SPECIFICATIONS

Fundamental AT Cut Parallel Resonant Crystal	
Nominal frequency	14.31818 MHz
Frequency tolerance	±50 ppm or better at 25°C
Operating temperature range	-25°C to +85°C
Storage temperature	-40°C to +85°C
Load capacitance	18 pF
Shunt capacitance	7 pF maximum
ESR	25 Ω



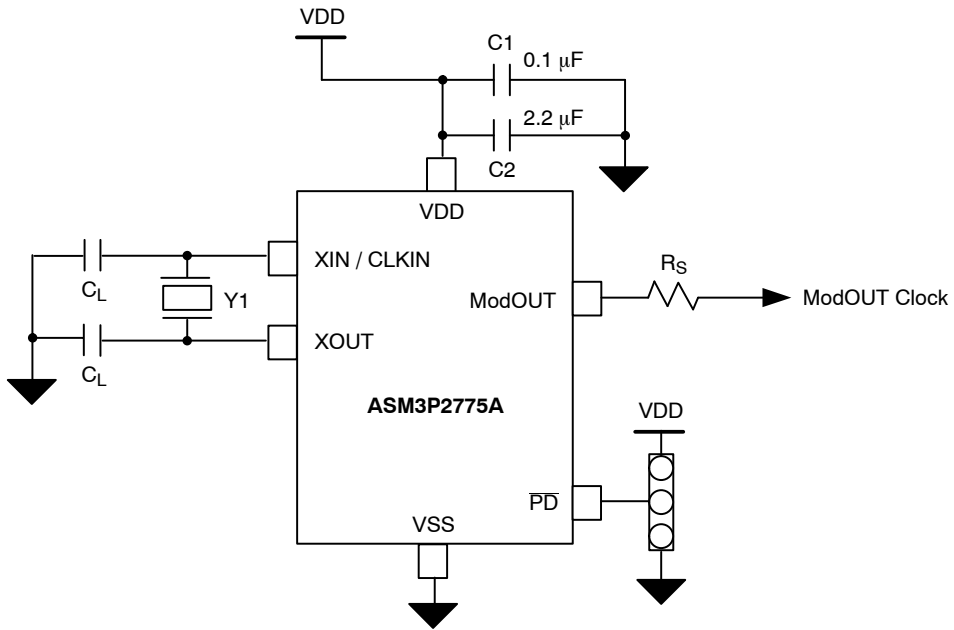
$$C_L = 2 * (C_P - C_S)$$

Where C_P = Load capacitance of crystal from crystal vendor datasheet.

C_S = Stray capacitance due to CIN, PCB, Trace, etc.

Figure 3. Typical Crystal Interface Circuit

ASM3P2775A



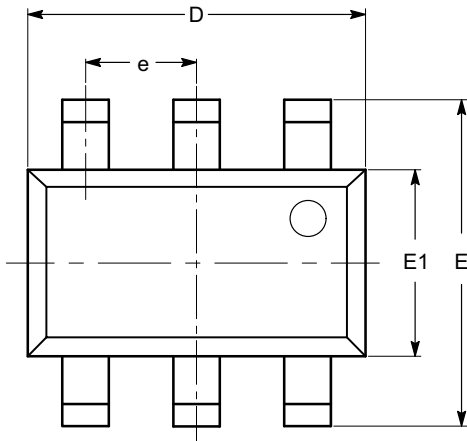
Note: Refer to *Pin Description* table for Functionality details.

Figure 4. Typical Application Schematic

ASM3P2775A

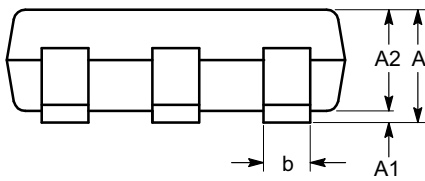
PACKAGE DIMENSIONS

TSOT-23, 6 LEAD
CASE 419AF-01
ISSUE O

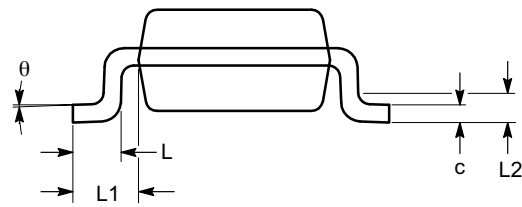


TOP VIEW

SYMBOL	MIN	NOM	MAX
A			1.00
A1	0.01	0.05	0.10
A2	0.80	0.87	0.90
b	0.30		0.45
c	0.12	0.15	0.20
D	2.90 BSC		
E	2.80 BSC		
E1	1.60 BSC		
e	0.95 TYP		
L	0.30	0.40	0.50
L1	0.60 REF		
L2	0.25 BSC		
θ	0°		8°



SIDE VIEW



END VIEW

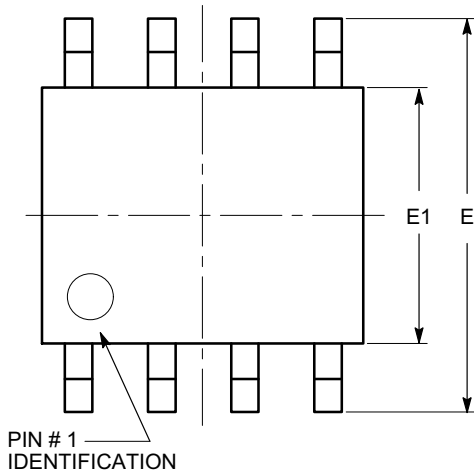
Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-193.

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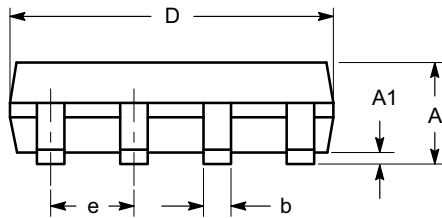
PACKAGE DIMENSIONS

SOIC 8, 150 mils
CASE 751BD-01
ISSUE O

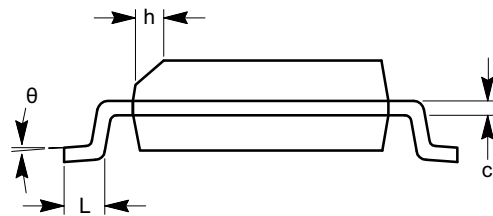


TOP VIEW

SYMBOL	MIN	NOM	MAX
A	1.35		1.75
A1	0.10		0.25
b	0.33		0.51
c	0.19		0.25
D	4.80		5.00
E	5.80		6.20
E1	3.80		4.00
e	1.27 BSC		
h	0.25		0.50
L	0.40		1.27
θ	0°		8°



SIDE VIEW



END VIEW

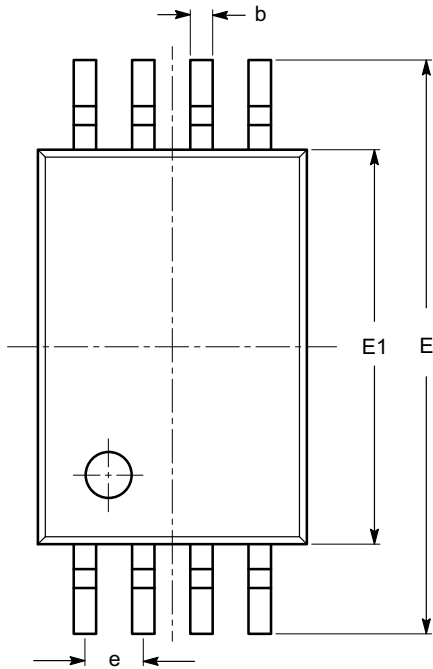
Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MS-012.

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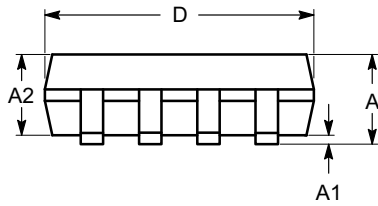
PACKAGE DIMENSIONS

TSSOP8, 4.4x3
CASE 948AL-01
ISSUE O

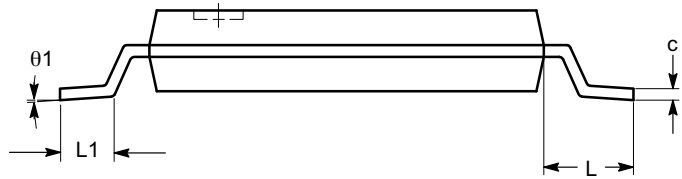


SYMBOL	MIN	NOM	MAX
A			1.20
A1	0.05		0.15
A2	0.80	0.90	1.05
b	0.19		0.30
c	0.09		0.20
D	2.90	3.00	3.10
E	6.30	6.40	6.50
E1	4.30	4.40	4.50
e	0.65 BSC		
L	1.00 REF		
L1	0.50	0.60	0.75
θ	0°		8°

TOP VIEW



SIDE VIEW



END VIEW


Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-153.

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Table 8. ORDERING INFORMATION

Part Number	Marking	Package Type	Temperature
ASM3P2775AF-06OR	X4LL	6-Pin TSOT-23, TAPE & REEL, Pb Free	Commercial
ASM3P2775AF-08TT	3P2775AF	8-Pin TSSOP, TUBE, Pb Free	Commercial
ASM3P2775AF-08TR	3P2775AF	8-Pin TSSOP, TAPE & REEL, Pb Free	Commercial
ASM3P2775AF-08ST	3P2775AF	8-Pin SOIC, TUBE, Pb Free	Commercial
ASM3P2775AF-08SR	3P2775AF	8-Pin SOIC, TAPE & REEL, Pb Free	Commercial
ASM3P2775AG-06OR	X3LL	6-Pin TSOT-23, TAPE & REEL, Green	Commercial
ASM3P2775AG-08TT	3P2775AG	8-Pin TSSOP, TUBE, Green	Commercial
ASM3P2775AG-08TR	3P2775AG	8-Pin TSSOP, TAPE & REEL, Green	Commercial
ASM3P2775AG-08ST	3P2775AG	8-Pin SOIC, TUBE, Green	Commercial
ASM3P2775AG-08SR	3P2775AG	8-Pin SOIC, TAPE & REEL, Green	Commercial

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